



深圳市诚芯微科技股份有限公司

SHENZHEN CHENGXINWEI TECHNOLOGY CO., LTD.

N-channel Enhancement Mode Mosfet

CX010N06

DESCRIPTION

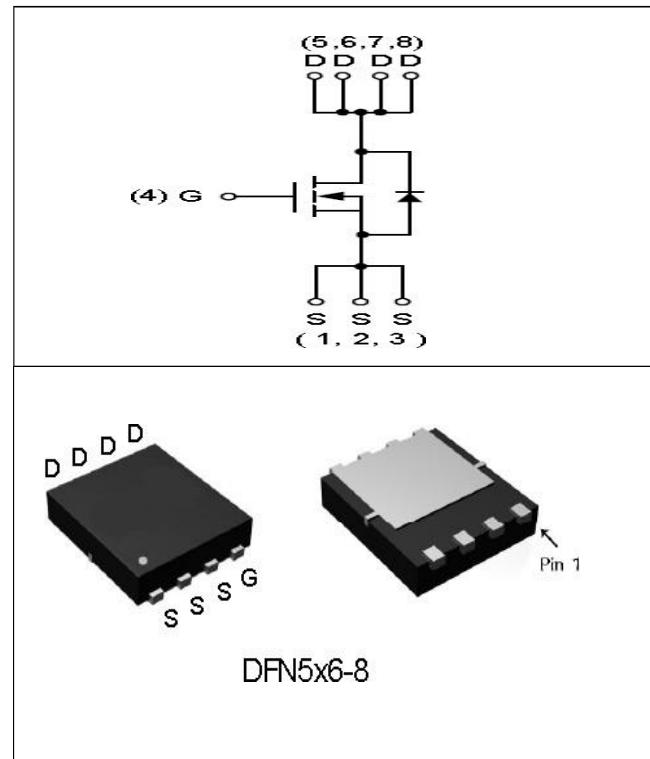
The CX010N06 is the high celldensity trenched N-CH MOSFETs,which provide excellent RDSON and GATE charge for mosr of the synchronous Rectification

GENERAL FEATURES

- VDS= 95V
- RDS(ON) = $6.1\text{ m }\Omega$ @ VGS= 10V
- Low RDS(on) & FOM
- Extremely low switching loss
- Excellent reliability and uniformity
- Fast switching and soft recovery

Application

- PD charger
- Switching voltage regulator
- DC-DC convertor
- Switched mode power supply



■ Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

| Parameter | | Symbol | Limit | Unit |
|--|-------------------------|-----------------|----------|---------------------------|
| Drain-source Voltage | | VDS | 95 | V |
| Gate-source Voltage | | VGS | ± 20 | V |
| Drain Current | $T_c=25^\circ\text{C}$ | I_D | 110 | A |
| | $T_c=100^\circ\text{C}$ | | 80 | |
| Pulsed Drain Current ^A | | I_{DM} | 280 | A |
| Total Power Dissipation | $T_c=25^\circ\text{C}$ | P_D | 88 | W |
| Single Pulse Avalanche Energy ^B | | EAS | 78 | mJ |
| Thermal Resistance Junction-to-Case ^C | | $R_{\theta JC}$ | 1.6 | $^\circ\text{C}/\text{W}$ |
| Thermal resistance, junction-ambient ⁴⁾ | | $R_{\theta JA}$ | 30 | $^\circ\text{C}/\text{W}$ |
| Junction and Storage Temperature Range | | T_J, T_{STG} | -55~+150 | $^\circ\text{C}$ |